Amendment to the Claims

This listing of Claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims

1. (Currently Amended) A substrate adapted for selective micron and nanometer scale deposition, the substrate having;

a support;

a conductive layer on the support;

a dielectric layer of a material which will hold an electrostatic charge, the dielectric layer disposed on the conductive layer, and

a chemically functional layer on the dielectric layer, the chemical functional layer providing a protective layer for the dielectric layer and a chemically reactive surface for compounds deposited on the surface;

whereby <u>the substrate is capable of having</u> electrostatic charge patterns may be formed in a predetermined manner upon or in the substrate thereupon or therein.

- (Original) A substrate as in Claim 1 wherein the support is selected from the group comprising a metal, glass, ceramic, or polymeric material and the support is clear or opaque and flexible or rigid.
- (Original) A substrate as in Claim 1 wherein the conductive layer is combined with the support.
 - 4. (Original) A substrate as in Claim 1 wherein the conductive layer is a very thin

layer and is transparent.

- (Currently Amended) A substrate as in Claim 1 wherein the conductive layer eonductive layer is vacuum-deposited onto the support.
- 6. (Original) A substrate as in Claim 1 wherein the conductive layer is selected from the group comprising a sputtered layer of metal or indium tin oxide, or a carbon nano-tube layer.
- (Currently Amended) A substrate as in Claim 1 wherein the dielectric layer is comprises a material selected from the group comprising consisting of a glass, a polymeric resin and a methylmethacrylate (MMA).
- (Currently Amended) A substrate as in Claim 1 wherein the dielectric in the dielectric layer is comprises a photoconductor.
- 9. (Currently Amended) A substrate as in Claim 8 wherein the photoconductor is selected from the group comprising zinc oxide, cadmium sulphide, lead sulphide, lead selenide, amorphous selenium, doped selenium, alloys of selenium including selenium-tellurium, selenium-arsenic, organic photoconductive materials including polyvinylearbazole (PVK) and complexes of polyvinylearbazole sensitised with trinitrofluorenone.
- (Currently Amended) A substrate as in Claim 1 wherein the chemically functional layer is comprises a material selected from the group comprising consisting of

a silane polymer, silicon dioxide, silicon nitride (Si_xN_y), titanium dioxide, Tyzer^{ztM}
organic titanates and zirconates, cross-linked or partially cross-linked epoxy novolac
resins, polymerised oligomers, cross-linked resins, functionalised parylene (a polymer of
di-para-xylyene), acrylates and methacrylates which may include functional groups,
multi-functional acrylates and methacrylates, and monomers which have been crosslinked
with a photoinitiator.

- 11. (Currently Amended) A substrate having;
- a support;
- a conductive layer on the support:
- a photoconductive layer of a material which is adapted to have an electrostatic charge thereon selectively dissipated upon receiving incident radiation, the photoconductive layer disposed on the conductive layer; and
- a chemically functional layer on the photoconductive layer, the chemical functional layer providing a protective layer for the photoconductive layer and a chemically reactive surface for compounds deposited on the surface;

whereby the substrate is capable of having electrostatic charge patterns may be formed in a selected array upon the substrate thereupon to influence the movement of charged droplets in a liquid medium on the substrate.

- 12. (Currently Amended) A substrate adapted for manufacture of DNA arrays, the substrate having;
 - a support;
 - a conductive layer on the support;
 - a photoconductive layer of a material which is adapted to have an electrostatic

charge thereon dissipated upon receiving incident radiation, the photoconductive layer disposed on the conductive layer; and

a chemically functional layer on the photoconductive layer, the chemical functional layer providing a protective layer for the photoconductive layer;

whereby the substrate is capable of having electrostatic charge patterns may be formed in a selected array upon the substrate thereupon to influence the movement of charged droplets in a liquid medium on the substrate;

the chemically functional layer comprising at least in part a chemically active material to which a binder molecule can be attached, the molecule being selected from the group consisting of a binder molecular and a binder molecule with at least one DNA oligomer joined thereto, whereby the substrate is capable of having a selected electric charge pattern may be generated upon the substrate thereupon by incident radiation to enable selective chemical de-protection of the binder molecules molecule or the at least one DNA oligomers oligomer already joined to a the binder molecule and application of nucleotides to selected binder molecules or to DNA oligomers already joined to a binder molecule.

- (Currently Amended) A substrate adapted for manufacture of DNA arrays, the substrate having;
 - a support;
 - a conductive layer on the support;
- a photoconductive layer of a material which is adapted to have an electrostatic charge thereon selectively dissipated upon receiving incident radiation, the photoconductive layer disposed on the conductive layer; and
- a chemically functional layer on the photoconductive layer, the chemical functional layer providing a protective layer for the photoconductive layer;

whereby the substrate is capable of having electric charge patterns may be formed in a selected array upon the substrate thereupon to influence the movement of charged droplets in a medium on the substrate; the chemically functional layer providing a surface to which a binder molecule can be attached.

14. (New) A substrate as in Claim 9 wherein the organic photoconductive materials comprise polyvinylcarbazole (PVK) or complexes of polyvinylcarbazole sensitised with trinitrofluorenone.